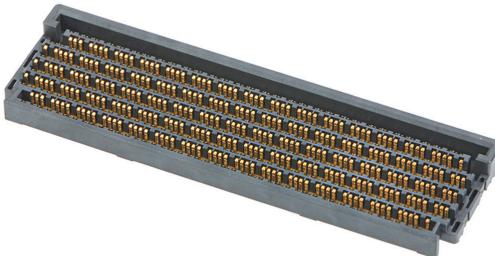




Part Number : 209311115

Product Description : Mirror Mezz
Hermaphroditic Connector, 2.50mm
Connector Height, BGA-Attach Mounting, 15
Pair, 11 Row, 688 Circuits, 0.76µm Gold (Au)
Plating



Series Number : 209311

Status : Active

Product Category : Board-to-Board
Connectors

Documents & Resources

Drawings

[Drawing 209311115_sd.pdf](#)

[Packaging Design Drawing 2093118500-000.pdf](#)

3D Models and Design Files

[2D Drawing DXF 209311115_dxf.dxf](#)

[2D Drawing DXF \(PDF\) 209311115.pdf](#)

[3D Model 209311115_stp.zip](#)

[Electrical Model Document 209311115EE-000.pdf](#)

[S-Parameter Model 209311115SP-000.zip](#)

Specifications

[Application Specification 2028280001-AS-000.pdf](#)

[Application Specification 2028289005PS-001.pdf](#)

[Application Specification 2093110001-AS-000.pdf](#)

[Product Specification 2028280001-000.pdf](#)

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2023)3788-DC (14 Jun 2023)
EU RoHS	Compliant per EU 2015/863

Multiple Part Product Compliance Statements

- Eu RoHS
- REACH SVHC
- Low-Halogen

Multiple Part Industry Compliance Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

EU RoHS Certificate of Compliance

Part Details

General

Status	Active
Category	Board-to-Board Connectors
Series	209311
Description	Mirror Mezz Hermaphroditic Connector, 2.50mm Connector Height, BGA-Attach Mounting, 15 Pair, 11 Row, 688 Circuits, 0.76µm Gold (Au) Plating
Application	Board-to-Board
Component Type	PCB Header
Product Family	Mirror Mezz Connectors
Product Name	Mirror Mezz
UPC	191130509140

Agency

CSA	LR19980
UL	E29179

Electrical

Current - Maximum per Contact	0.75A (1 Oz Cu Trace), 1.0A (1.5 Oz Cu Trace), 1.2A (2 Oz Cu Trace)
Voltage - Maximum	30V AC (RMS)/DC

Physical

Breakaway	No
Circuits (Loaded)	688
Circuits (maximum)	688
Color - Resin	Black
Durability (mating cycles max)	100
First Mate / Last Break	No
Glow-Wire Capable	No
Guide to Mating Part	Yes
Keying to Mating Part	None
Lock to Mating Part	No
Mated Height	5.00mm
Material - Metal	High Performance Alloy (HPA)
Material - Plating Mating	Gold
Material - Plating Termination	BGA Solder
Material - Resin	High Temperature Thermoplastic
Net Weight	5.360/g
Number of Rows	11
Orientation	Vertical
Packaging Type	Embossed Tape on Reel
PCB Locator	Yes
PCB Retention	Yes
Pitch - Mating Interface	1.50mm, 4.00mm
Plating min - Mating	0.762µm
Polarized to Mating Part	Yes
Polarized to PCB	Yes
Shrouded	Yes
Stackable	Yes
Temperature Range - Operating	-55° to +105°C
Termination Interface Style	Surface Mount

Solder Process Data

Max-Duration	20
Lead-Free Process Capability	REFLOW
Max-Cycle	1
Max-Temp	260

Mates With / Use With

Mates with Part(s)

Description	Part Number
Mates With	This is a hermaphroditic, self-mating part.

This document was generated on Jan 24, 2024